

ABSTRACT

Methods for forming electrical connections between two components, as well as various embodiments of devices created according to the disclosed methods, are described. The method includes forming a depression in a land disposed on a first component, wherein the depression is shaped to receive a conductive bump extending from a second component. A layer of conductive material is disposed between the land and the conductive bump, and the conductive material layer is used to form an electrical connection between the land and conductive bump.